

HEWLETT-PACKARD COMPANY  
Intellectual Property Administration  
P. O. Box 272400  
Fort Collins, Colorado 80527-2400

## PATENT APPLICATION

ATTORNEY DOCKET NO. 10015382-3IN THE  
UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Buswell et al.

Confirmation No.: 7243

Application No.: 10/601,149

Examiner: Stephens, J.

Filing Date: 06-20-2003

Group Art Unit: 2853

Title: Slotted Substrate and Method of Making

Commissioner for Patents  
PO Box 1450  
Alexandria, VA 22313-1450

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MAY 03 2004

## TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT

Sir:

Transmitted herewith is/are the following in the above-identified application:

- (X) Response/Amendment ( ) Petition to extend time to respond  
( ) New fee as calculated below ( ) Supplemental Declaration  
(X) No additional fee (Address envelope to "Mail Stop Non-Fee Amendment")  
( ) Other: \_\_\_\_\_ (fee \$ \_\_\_\_\_)

OFFICIAL

CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY						
(1) FOR	(2) CLAIMS REMAINING AFTER AMENDMENT	(3) NUMBER EXTRA	(4) HIGHEST NUMBER PREVIOUSLY PAID FOR	(5) PRESENT EXTRA	(6) RATE	(7) ADDITIONAL FEES
TOTAL CLAIMS	21	MINUS	21	= 0	X \$18	\$ 0
INDEP. CLAIMS	3	MINUS	3	= 0	X \$86	\$ 0
[ ] FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM					+ \$290	\$ 0
EXTENSION FEE	1ST MONTH \$110.00	2ND MONTH \$420.00	3RD MONTH \$950.00	4TH MONTH \$1480.00	\$ 0	
OTHER FEES						\$
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT						\$ 0

Charge \$ 0 to Deposit Account 08-2025. At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account 08-2025 pursuant to 37 CFR 1.25. Additionally please charge any fees to Deposit Account 08-2025 under 37 CFR 1.16, 1.17, 1.19, 1.20 and 1.21. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

(X) I hereby certify that this paper is being transmitted  
to the Patent and Trademark Office facsimile  
number (703) 872-9306 on 5-03-2004  
Number of pages: 12

Typed Name: Carlin Taylor

Signature: 

Buswell et al.

By 

Paul W. Mitchell

Attorney/Agent for Applicant(s)  
Reg. No. 44,453

Date: 5/3/04

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**IN THE UNITED STATES  
PATENT AND TRADEMARK OFFICE****OFFICIAL**

Inventors: Buswell et al. Examiner: Stephens, Juanita  
5 Serial No: 10/601,149 Group Art Unit: 2853  
Filing Date: 6/20/03 Confirmation No: 7243  
Title: Slotted Substrate and Method of Making

To: Commissioner of Patents and Trademarks  
10 PO Box 1450  
Alexandria, VA 22313-1450

From: Hewlett-Packard Development Company, L.P.  
Intellectual Property Administration  
15 P.O. Box 272400  
Fort Collins, Colorado 80527-2400

**INTRODUCTORY COMMENTS**

This communication is in response to the Office Action dated 2/10/04, for  
20 which a three-month shortened statutory period for response is set for 5/10/04.  
Please amend the above-identified application in accordance with the directions  
set forth below.

Amendments to the Specification are reflected on page 2 of this paper.

Amendments to the Claims are reflected on the list of claims which  
25 begins on page 3 of this paper.

Remarks/Arguments begin on page 8 of this paper.